

#### **RESINIFY – TECHNICAL DATA SHEET**

**Product Name:** NanoCeram **RT Code:** RT-CP4500 **Category:** Engineering Resin – Composite / Ceramic-Filled

### 1. Product Description

NanoCeram is a high-performance, ceramic-reinforced engineering resin designed for extreme stiffness, dimensional stability, and low thermal expansion. Enhanced with **nano-scale ceramic fillers**, it offers significantly improved modulus, hardness, and rigidity while maintaining printability across LCD, mSLA, and DLP systems. Parts printed with NanoCeram exhibit a **ceramic-like feel**, high scratch resistance, and excellent resistance to deformation under load. This material is suitable for high-precision tooling, durable prototypes, and functional engineering components requiring stability and stiffness.

### 2. Key Features & Benefits

- High stiffness & rigidity with ceramic-like performance
- Excellent dimensional accuracy and low shrinkage
- Low thermal expansion for precision applications
- High hardness and excellent surface finish
- Improved thermal resistance vs. standard resins
- Strong mechanical stability under continuous load

## 3. Mechanical & Thermal Properties

| Property            | Value                                   |
|---------------------|---|
| Tensile Strength    | 60–75 MPa                               |
| Tensile Modulus     | <b>3,000–4,500 MPa</b> (high stiffness) |
| Elongation at Break | 2–4%                                    |



| Property          | Value           |
|-------------------|-----------------|
| Flexural Strength | 100–130 MPa     |
| Flexural Modulus  | 3,500–5,000 MPa |
| Impact Strength   | 10–18 J/m       |
| HDT @ 0.45 MPa    | 70–90°C         |
| Shore Hardness    | 88–90D          |
| Water Absorption  | <0.30%          |
| Shrinkage         | 0.20-0.40%      |
| Density           | 1.30–1.45 g/cm³ |
| Viscosity         | 900–1500 cP     |

Note: Values vary based on filler load and curing profile.

# 4. Recommended 3D Printing Parameters

| Parameter       | Setting          |
|-----------------|------------------|
| Printer Type    | LCD / mSLA / DLP |
| Wavelength      | 385–405 nm       |
| Layer Thickness | 50–100 μm        |
| Normal Exposure | 3.2–4.2 sec      |



| Parameter              | Setting                                |
|------------------------|--|
| <b>Bottom Layers</b>   | 6–10                                   |
| <b>Bottom Exposure</b> | 50–75 sec                              |
| Lift Speed             | Medium                                 |
| Rest Time              | Recommended for ceramic-filled systems |

### 5. Post-Processing

- 1. **Wash**: Wash for 3–5 minutes in IPA or a dedicated resin cleaner.
- 2. **Dry**: Dry parts completely.
- 3. Cure: UV post-cure for 25–40 minutes.
  - An optional mild heat cure at **60°C for 30 minutes** can be applied.
- 4. Avoid aggressive mechanical cleaning to preserve the surface finish.

### 6. Applications

- High-precision jigs, fixtures, and dimensional calibration tools
- Stiff structural components and load-bearing prototypes
- Mold masters, alignment tools, and electronics housings requiring rigidity
- Components requiring low creep and minimal deformation

## 7. Storage & Handling

- Store in a tightly sealed container between 10–30°C, away from light.
- Stir well before use, as ceramic fillers may settle.
- **Shelf Life:** 12 months from the date of manufacture when stored properly.

## 8. Compliance

RoHS



- **REACH**
- Tested in accordance with ASTM D638, D790.

This document is subject to change. For the latest version, please contact Resinify **Technology LLC. RESINIFY – Innovating Additive Manufacturing Materials**